

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET MCH3478 — General-Purpose Switching Device **Applications**

• Ultrahigh speed switching

· Halogen free compliance

Features

- · Low ON-resistance
- 1.8V drive
- Protection diode in

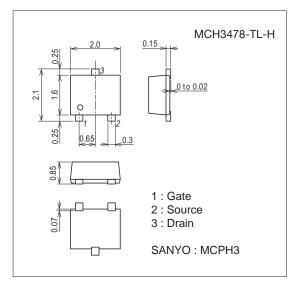
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ID		2	А
Drain Current (PW≤10s)	ID	Duty cycle≤1%	2.5	А
Drain Current (Pulse)	IDP	PW⊴10µs, duty cycle≤1%	8	А
Allowable Power Dissipation	De	When mounted on ceramic substrate (900mm ² ×0.8mm)	0.8	W
	PD	When mounted on ceramic substrate (900mm ² x0.8mm), PW=10s	1.2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ) 7019A-003



Product & Package Information

: MCPH3 • Package

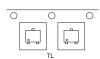
• JEITA, JEDEC

: SC-70, SOT-323

• Minimum Packing Quantity : 3,000 pcs./reel

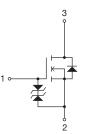
Packing Type : TL

Marking





Electrical Connection



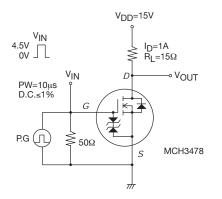
SANYO Semiconductor Co., Ltd. http://semicon.sanyo.com/en/network

60612TKIM/21809PE MSIM TC-00001860 No. A1353-1/7

Electrical Characteristics at Ta=2	5°C
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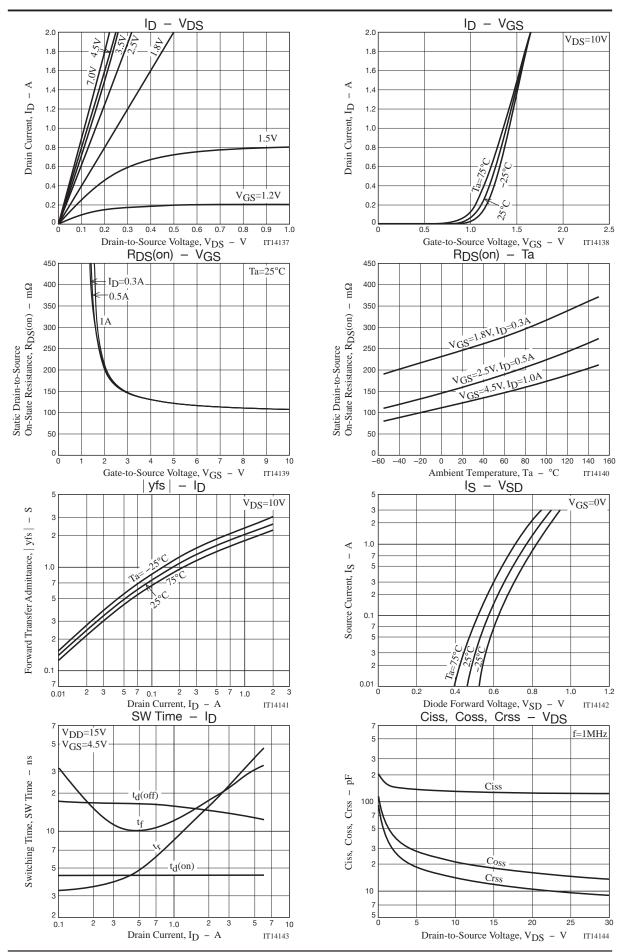
Parameter	Symbol	Conditions		Unit		
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =30V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±8V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	0.4		1.3	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =1A	1.2	2.0		S
	R _{DS} (on)1	ID=1A, VGS=4.5V		125	165	mΩ
Static Drain-to-Source On-State Resistance	R _{DS} (on)2	I _D =0.5A, V _{GS} =2.5V		165	235	mΩ
	R _{DS} (on)3	ID=0.3A, VGS=1.8V		250	375	mΩ
Input Capacitance	Ciss			130		pF
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		21		pF
Reverse Transfer Capacitance	Crss			14		pF
Turn-ON Delay Time	t _d (on)			4.4		ns
Rise Time	tr			8.7		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		16		ns
Fall Time	tf			12		ns
Total Gate Charge	Qg			1.7		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=4.5V, ID=2A		0.25		nC
Gate-to-Drain "Miller" Charge	Qgd	1		0.38		nC
Diode Forward Voltage	V _{SD}	IS=2A, VGS=0V		0.85	1.2	V

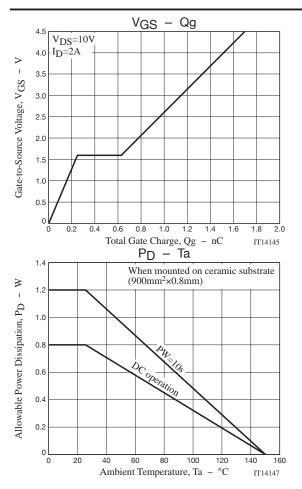
Switching Time Test Circuit

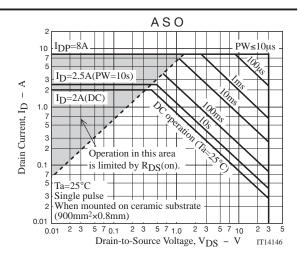


Ordering Information

Device	Device Package		memo		
MCH3478-TL-H	CH3478-TL-H MCPH3		Pb Free and Halogen Free		







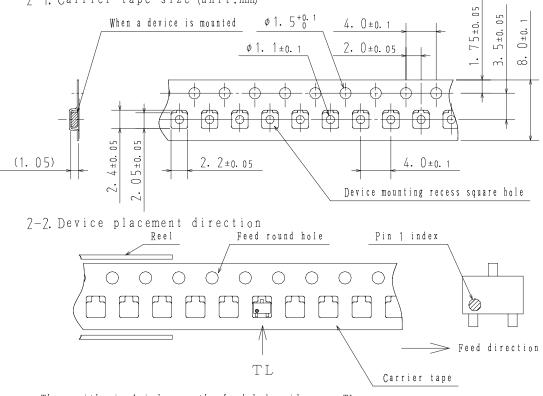
Taping Specification MCH3478-TL-H

1. Packing Format

Package Name	Carrier Tape	Maximun Number of devices contained (pcs) Packing format				format			
Taczalo Mame	Санттет тарс Туре	Reel		outerbox	Inn	ier B	-		Outer BOX (A-7)
МСРНЗ	MCPH3	3,000	15,000	90,000	5 ree	ls cont	ained		6 inner boxes contained
		3, 000	13, 000		Dimensions:mm (external)			ternal)	Dimensions:mm (external)
					18	3×7	2×1	85	440×195×210
Packing met	Type LOT	No. tity in		ITYPE 0 0 0 C IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	n i t : m 5 9 000000 11111111111111111111111111111	m)	tion s al is	The ford distri	r box label a label at the time of factory shipment: m of a label may change in physical bution process. 108 TYPE CODE IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII

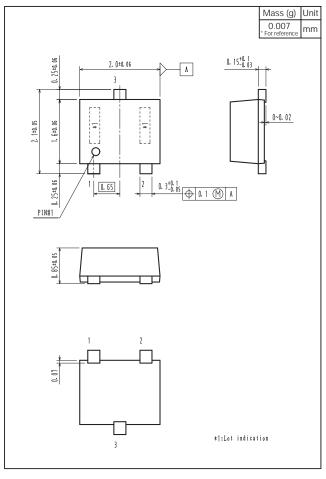
2. Taping configuration

2-1. Carrier tape size (unit:mm)

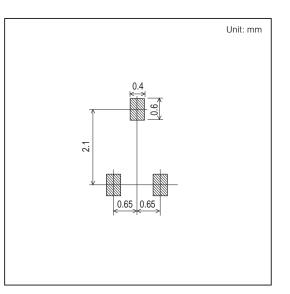


Those with pin 1 index on the feed hole side $\cdots \cdots TL$

Outline Drawing MCH3478-TL-H



Land Pattern Example



Note on usage : Since the MCH3478 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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